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(12) **United States Design Patent**  
**Hutchieson**

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(54) **HEADPHONE**

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379/430, 431, 433.01; 381/380, 381; 455/575.1,  
455/90.3; D29/112; 2/209; D24/106, 174;  
128/866

See application file for complete search history.

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*Primary Examiner*—Paula Greene

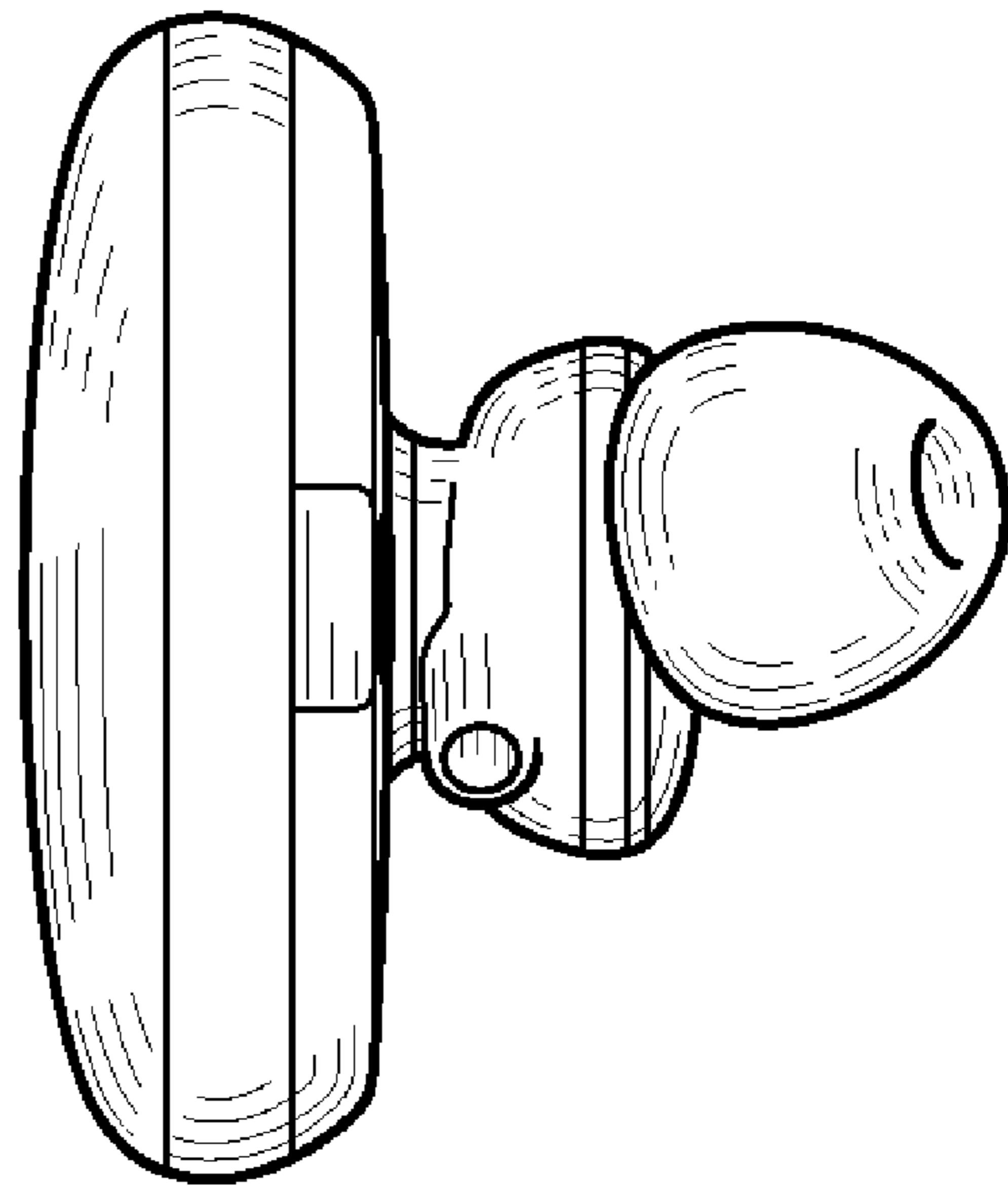
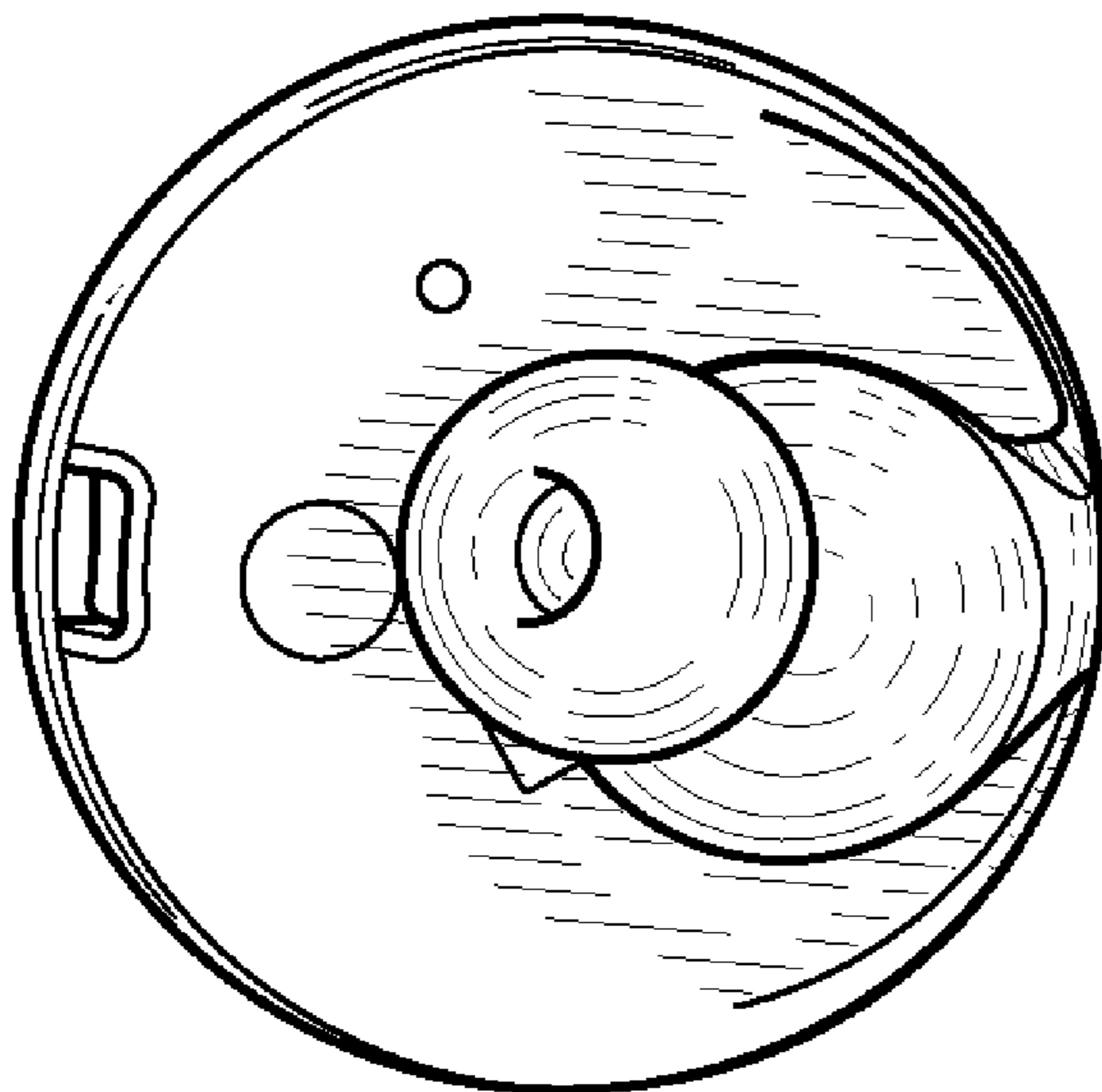
(57) **CLAIM**

The ornamental design for a headphone, as shown.

**DESCRIPTION**

FIG. 1 is a perspective view showing my design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a rear elevational view thereof;  
FIG. 4 is a right side elevational view thereof;  
FIG. 5 is a left side elevational view thereof;  
FIG. 6 is a top plan view thereof; and,  
FIG. 7 is a bottom plan view thereof.

**1 Claim, 2 Drawing Sheets**



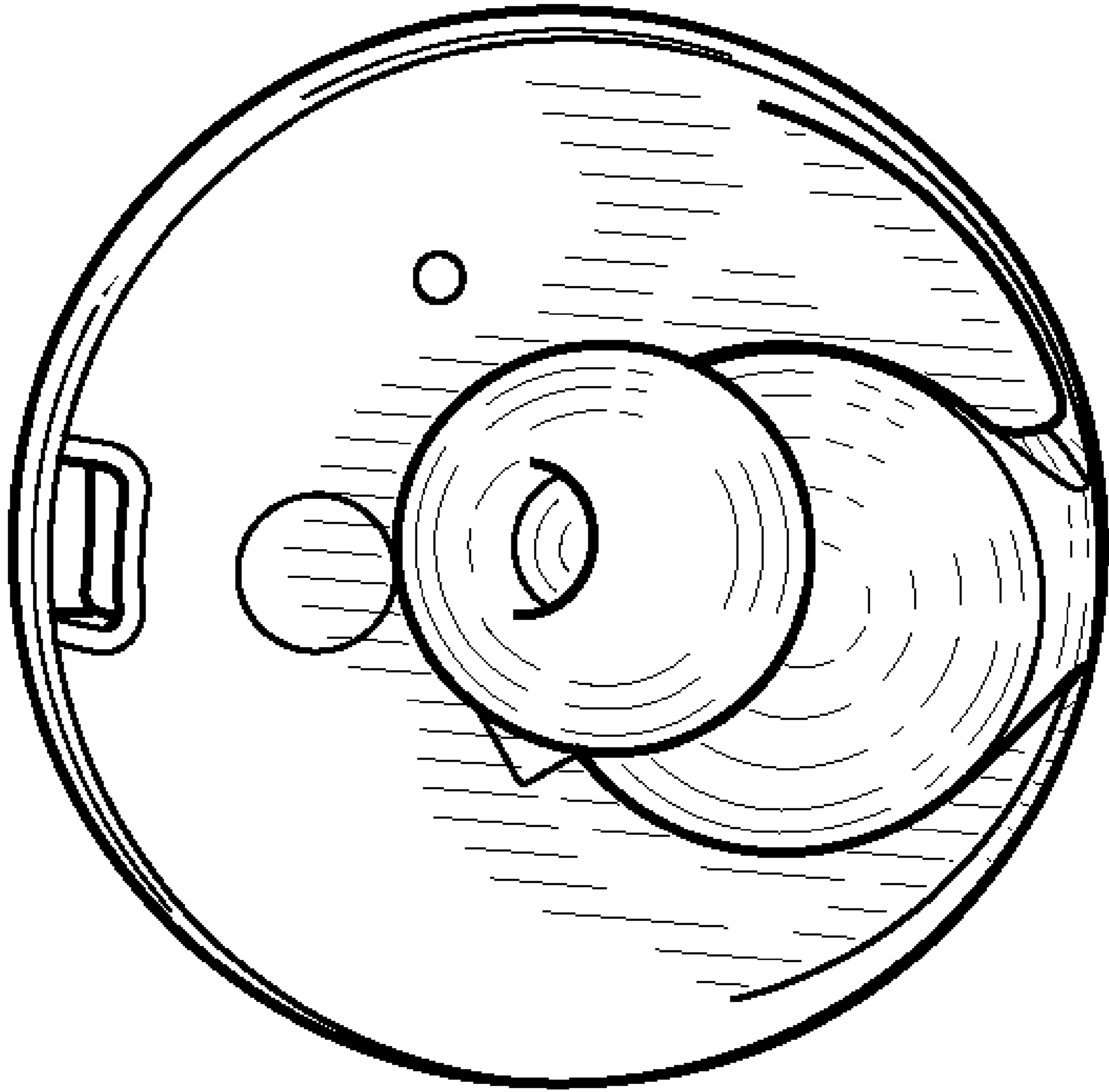


FIG. 1

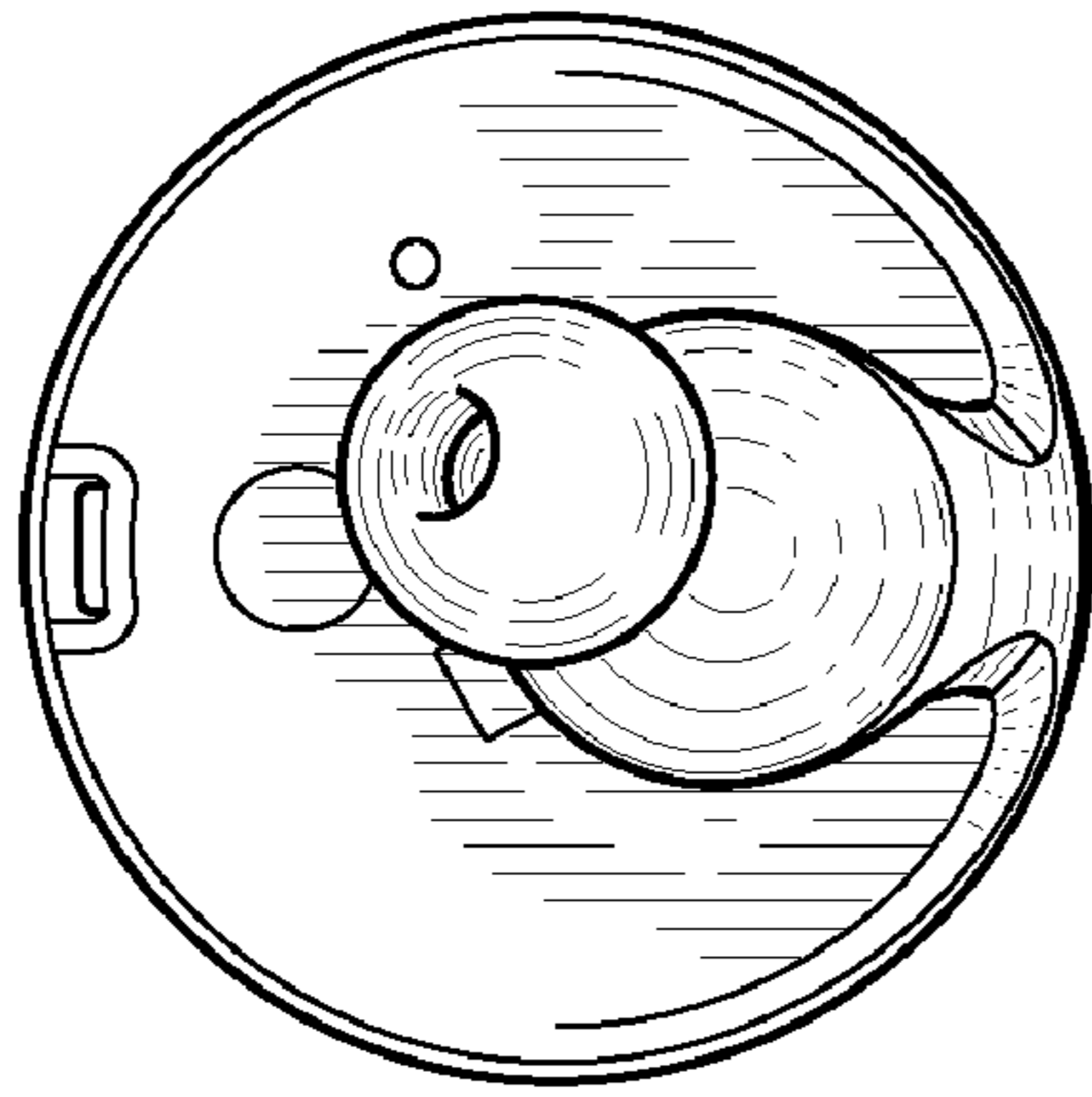


FIG. 2

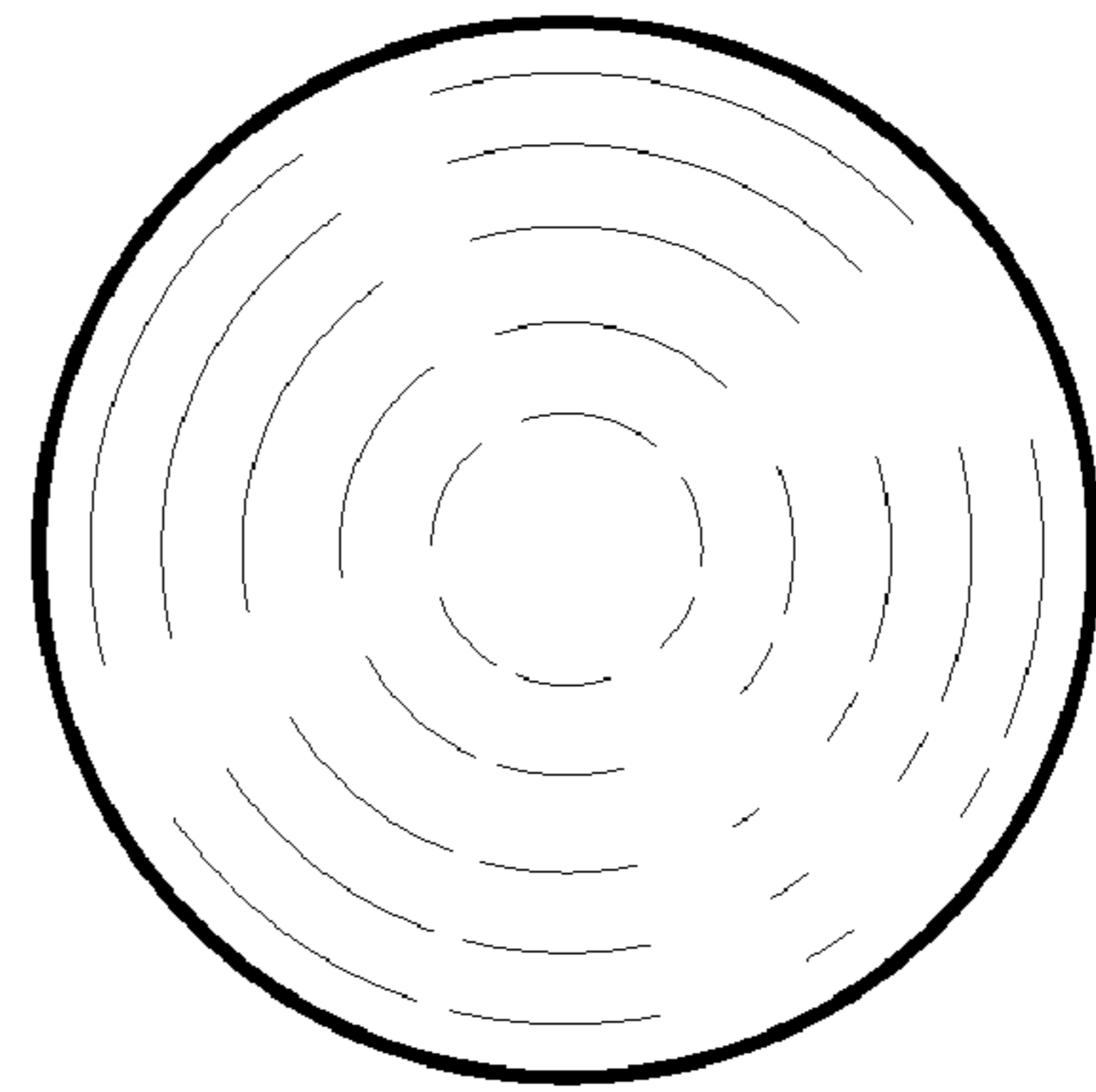


FIG. 3

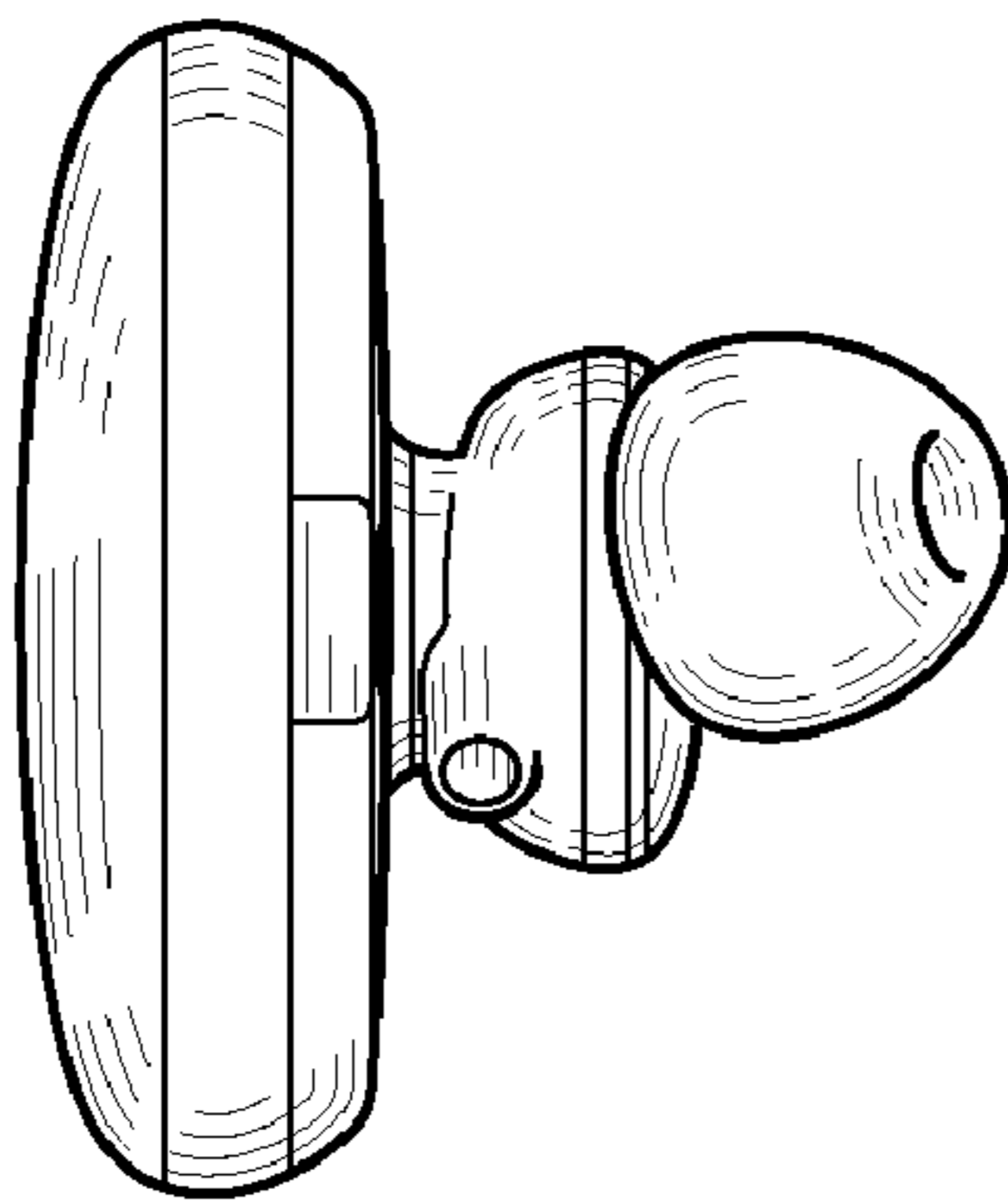


FIG. 4

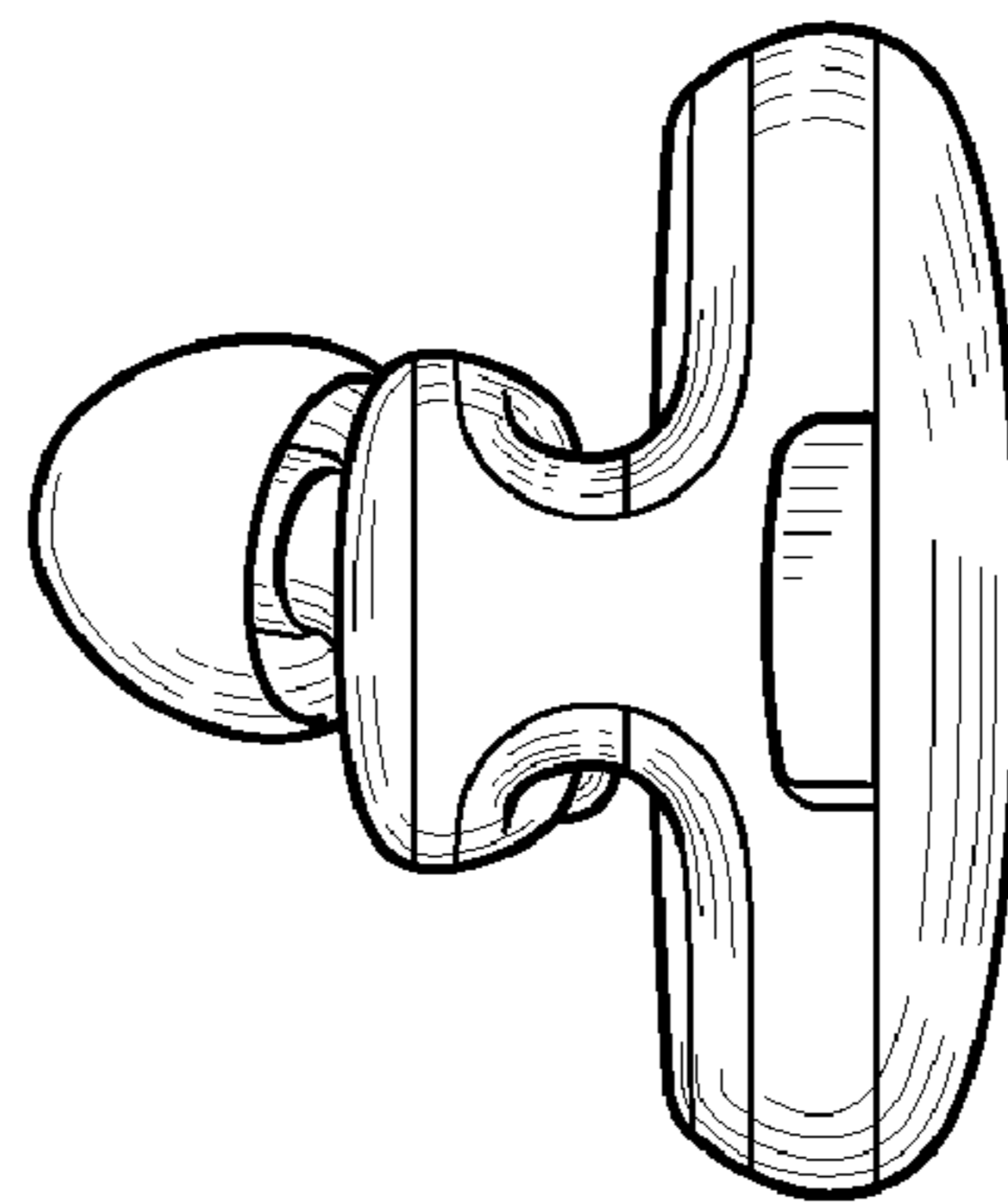


FIG. 5

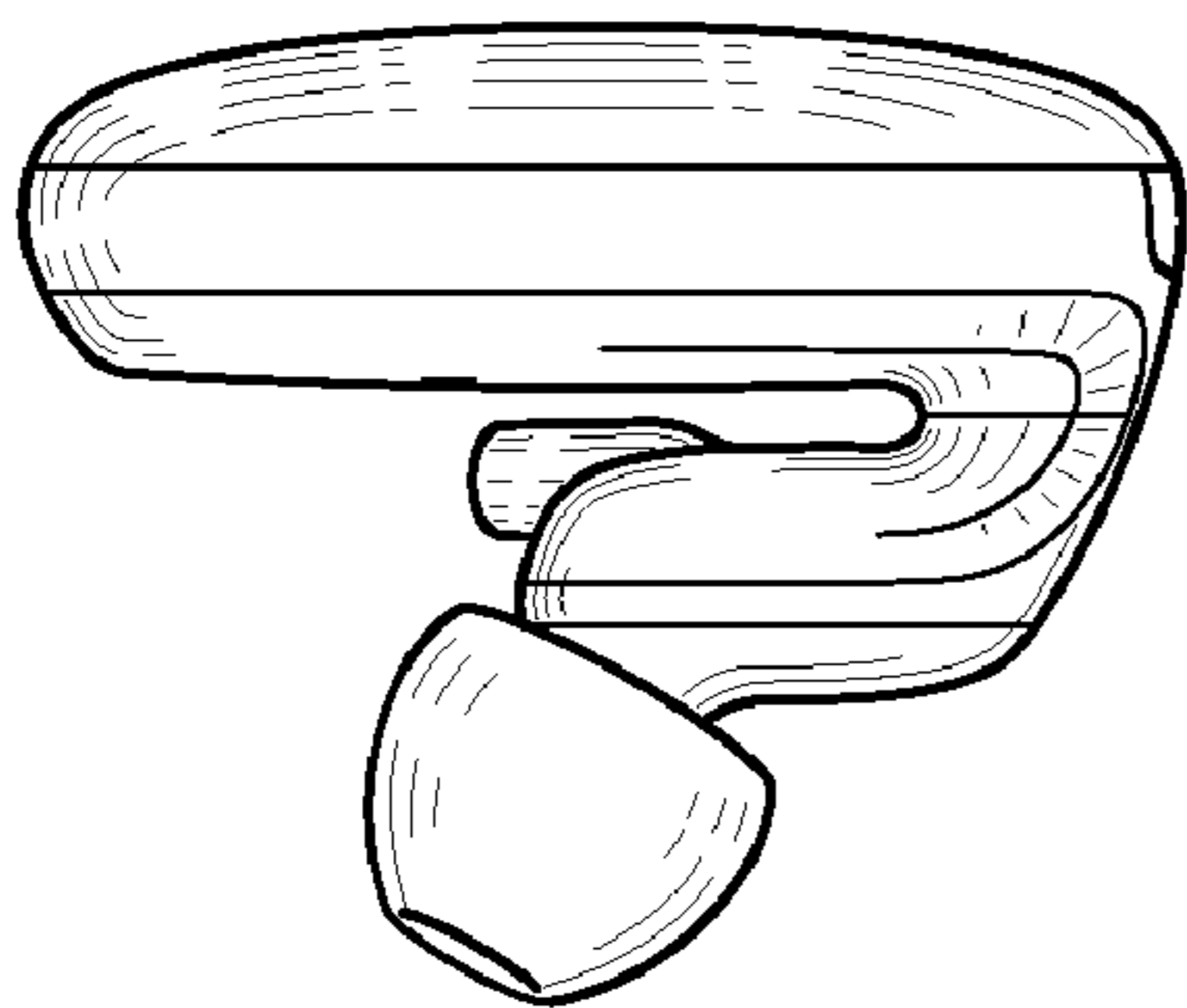


FIG. 6

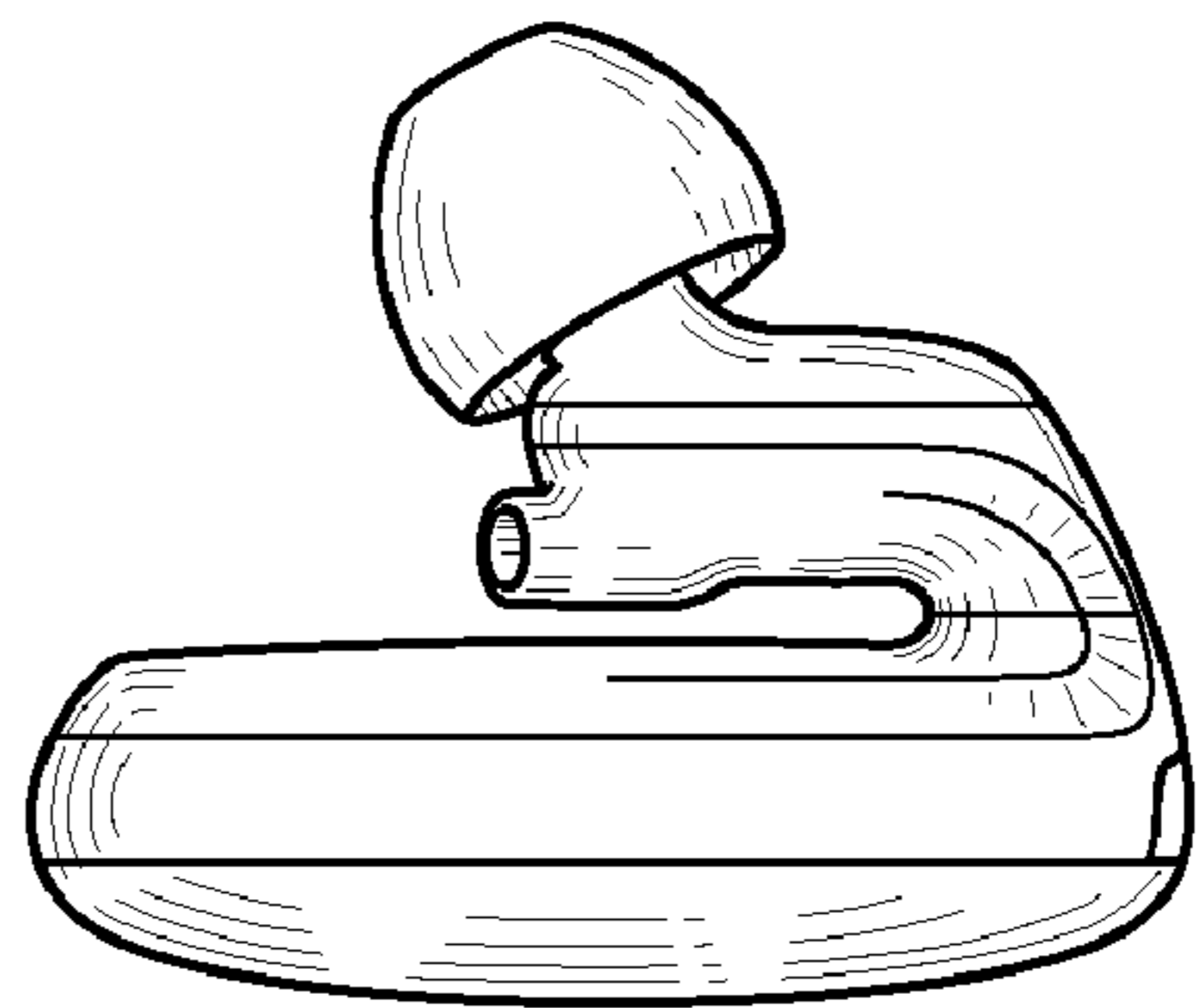


FIG. 7